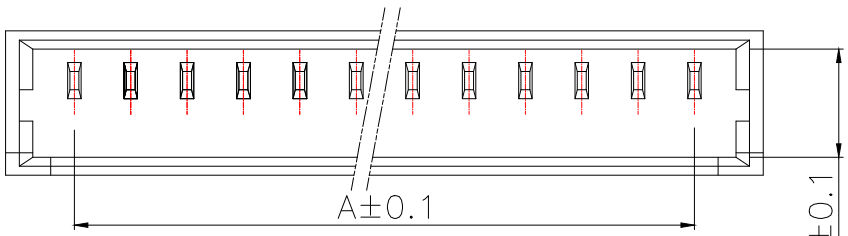
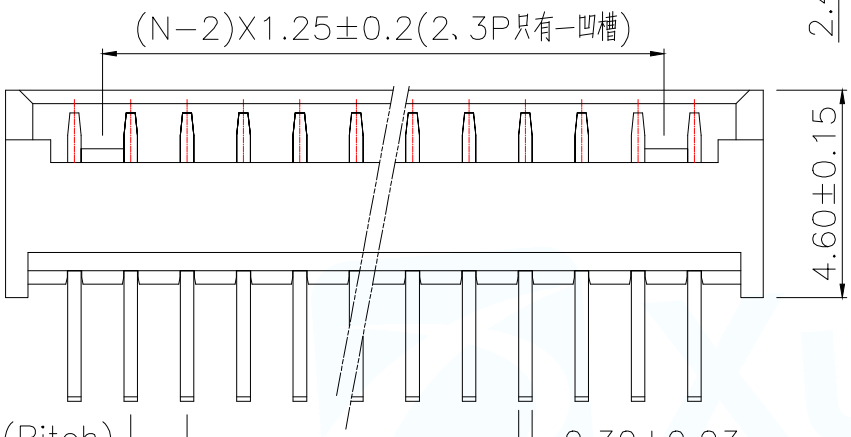
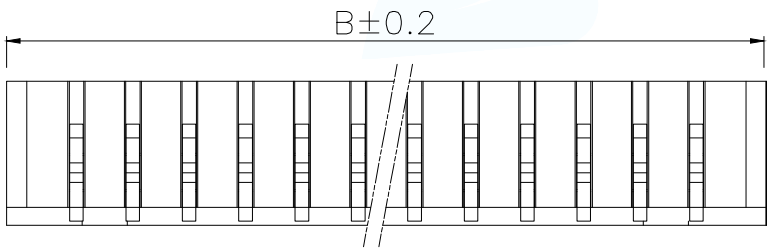
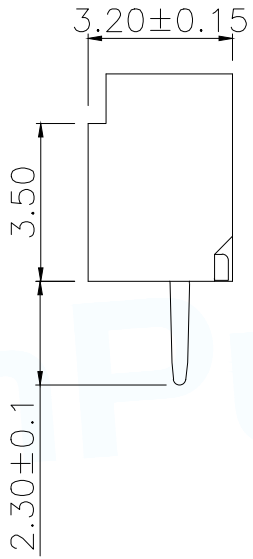
ROHS Compliant

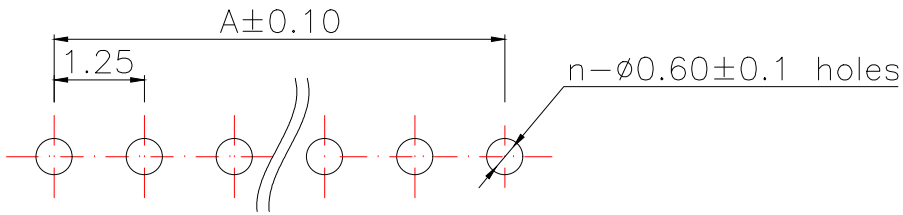
MAPX	MODIFICATION	DATE	DRAW	APPROVE











PCB寸法

PCB Layout

Part No	Pin	A	B
WAFER−MX1.25B−2PZZ	2	1.25	4.30
WAFER−MX1.25B−3PZZ	3	2.50	5.55
WAFER−MX1.25B−4PZZ	4	3.75	6.80
WAFER−MX1.25B−5PZZ	5	5.00	8.05
WAFER−MX1.25B−6PZZ	6	6.25	9.30
WAFER−MX1.25B−7PZZ	7	7.50	10.55
WAFER−MX1.25B−8PZZ	8	8.75	11.80
WAFER−MX1.25B−9PZZ	9	10.00	13.05
WAFER−MX1.25B−10PZZ	10	11.25	14.30
WAFER−MX1.25B−11PZZ	11	12.50	15.55
WAFER−MX1.25B−12PZZ	12	13.75	16.80
WAFER−MX1.25B−13PZZ	13	15.00	18.05
WAFER−MX1.25B−14PZZ	14	16.25	19.30
WAFER−MX1.25B−15PZZ	15	17.50	20.55
WAFER−MX1.25B−16PZZ	16	18.75	21.80

技术指标:

1、塑件表面应光洁、无毛刺、明显收缩、缺陷、裂纹等现象;

2、温度范围:−25°C~85°C;

3、额定电压:200V，AC，DC(等效);

4、额定电流:1A

5、接触电阻:≤0.03Ω;

6、绝缘电阻:≥1000MΩ;

7、耐压:1000V,AC/minute.

ROHS管理规定:

1、禁止使用含有ROHS指令所限制的物质.

2、对应的SGS或ITS出具的ICP−AES数据、不可测定物质的成分表,有效期一年.

序号	名称	材料	数量	附注
2	端子 Contact	黄铜 Brass	n*1	电镀(锡):整个表面镀底镍30u"MIN,再镀锡80u".MIN.
1	基座 Wafer	PA66(UL94 V−0)	1	本色

MANUFACTURE DWG	东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co,Ltd		
UNLESS OTHERWISE SPECIFED TOLERANCES		TITLE: WAFER−MX1.25B−直针	
DECIMALS:	ANGLES:	PAR	WAFER−MX1.25B−NPZZ
.X:±0.10	X.°:±5°	DWN	Lucas
.XX:±0.05	X.X°:±2°	CHKD	Ethan
.XXX:±0.02		APVD	Jacob
CUSTOMER COPY		SCALE1:1	UNIT:MM
		SIZE:A4	SHEET:1F1 REV:A

Unikeyic Electronics

Global Electronic Components Distributor

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XUNPU:

FPC-1.0AX-14PWCR-H25 FPC-1.0AX-4PWCR-H25 WAFER-VH3.96-4PLB FPC-1.0HF-4PWAR-H20 FPC-0.5AL-6PB FPC-0.5AS-5PWCR-H20 FPC-0.5AX-24PWCR-H20 FPC-0.5HF-10PWBR-H20 WAFER-PH2.0-11PZZ WAFER-PH2.0-2PJK WAFER-PH2.0-3PWB FPC-0.5FX-20PWBH15 WAFER-GH1.25-6PLB WAFER-PH2.0-8PLB WAFER-WBM4.2-16PJK-GB FPC-0.5FX-4PWBH15 FPC-0.5FX-4PWCR-H20 TYPEC-304YDSW-ACP16 WAFER-PH2.0-6PWB MU-103-ARW64 SMA-KWE-323C-H13X23-LW WAFER-MX1.25B-8PWB FPC-0.5FX-14PWCR-H20 RJ45-005-014-11 PHB2.0-02-20PZZ WAFER-XH2.54-4PWZ-H62 DC-031A-A100 HDMI-212L FPC-0.5AX-30PWCR-H20 FPC-0.5FX-16PWCR-H20